

PJD55N04S-AU

40V N-Channel Enhancement Mode MOSFET

Voltage **40 V**

Current **87 A**

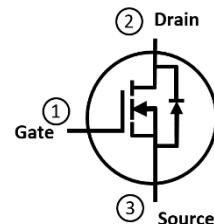
Features

- $R_{DS(ON)}$, $V_{GS} @ 10V$, $I_D @ 20A < 5.3m\Omega$
- $R_{DS(ON)}$, $V_{GS} @ 4.5V$, $I_D @ 20A < 7.4m\Omega$
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case : TO-252AA Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.3217 grams

TO-252AA



Maximum Ratings and Thermal Characteristics ($T_A=25^\circ C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^(Note 3)	I_D	87	A
		61	
Pulsed Drain Current ^(Note 1)	I_{DM}	348	A
Power Dissipation	P_D	71	W
		36	
Continuous Drain Current ^(Note 4)	I_D	17.7	A
		14.8	
Power Dissipation	P_D	3	W
		2.1	
Single Pulse Avalanche Energy ^(Note 5)	E_{AS}	49	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~175	°C
Thermal Resistance ^(Note 4)	Junction to Case	$R_{\theta JC}$	2.1
	Junction to Ambient	$R_{\theta JA}$	50
			°C/W

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Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	40	-	-	V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=50\mu\text{A}$	1.1	1.7	2.3	
Drain-Source On-State Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	-	4.2	5.3	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$	-	5.7	7.4	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$	-	-	± 1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
Dynamic ^(Note 6)						
Total Gate Charge	Q_g	$V_{\text{DS}}=32\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=10\text{V}$	-	20	-	nC
Gate-Source Charge	Q_{gs}		-	3.1	-	
Gate-Drain Charge	Q_{gd}		-	6.4	-	
Input Capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	1328	-	pF
Output Capacitance	C_{oss}		-	276	-	
Reverse Transfer Capacitance	C_{rss}		-	31	-	
Gate resistance	R_g	$f=1\text{MHz}$	-	0.8	-	Ω
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}}=32\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\Omega$ <small>(Note 2)</small>	-	11	-	ns
Turn-On Rise Time	t_r		-	3	-	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	28	-	
Turn-Off Fall Time	t_f		-	5	-	
Drain-Source Diode						
Diode Forward Current	I_s	$T_c=25^\circ\text{C}$	-	-	87	A
Pulsed Diode Forward Current	I_{SM}		-	-	348	
Diode Forward Voltage	V_{SD}	$I_s=20\text{A}, V_{\text{GS}}=0\text{V}$	-	0.85	1.3	V
Reverse Recovery Time	T_{rr}	$V_{\text{GS}}=0\text{V}, I_s=20\text{A}$ $dI_s/dt=100\text{A}/\mu\text{s}$	-	23	-	ns
Reverse Recovery Charge	Q_{rr}		-	15	-	nC

NOTES :

1. Pulse width $\leq 100\mu\text{s}$, Duty cycle $\leq 2\%$.
2. Essentially independent of operating temperature typical characteristics.
3. Chip capability with an $R_{\theta JC}=2.1^\circ\text{C}/\text{W}$.
4. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
5. The test condition is $L=0.5\text{mH}, I_{AS}=14\text{A}, V_{DD}=30\text{V}, V_{GS}=10\text{V}$, Starting $T_j=25^\circ\text{C}$. the chip is about to carry $I_{AS} \approx 28\text{A}$.
6. Guaranteed by design, not subject to production testing.

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TYPICAL CHARACTERISTIC CURVES

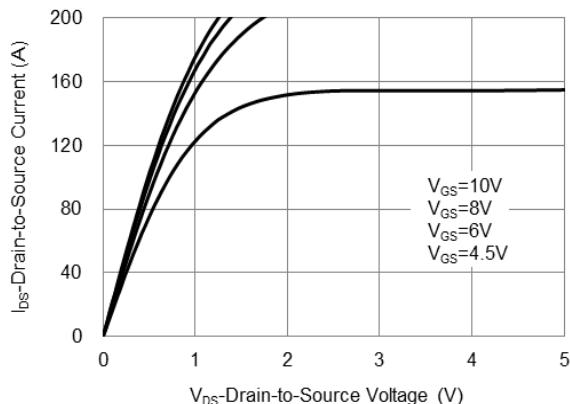


Fig.1 On-Region Characteristics

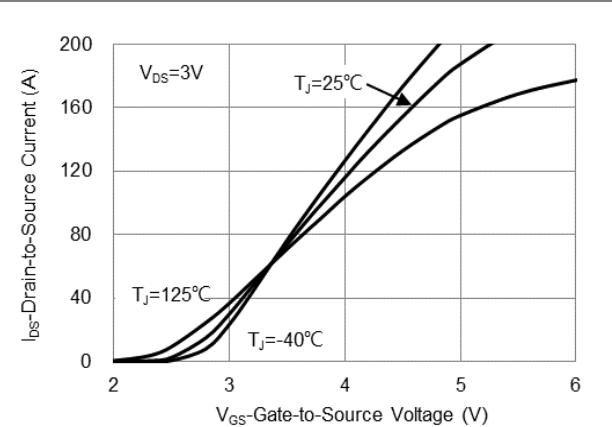


Fig.2 Transfer Characteristics

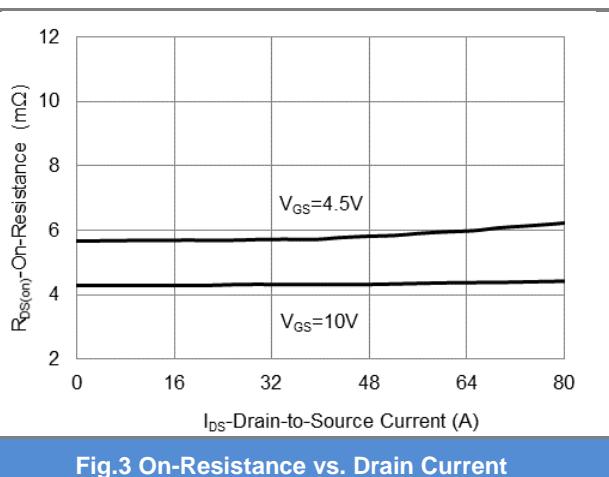


Fig.3 On-Resistance vs. Drain Current

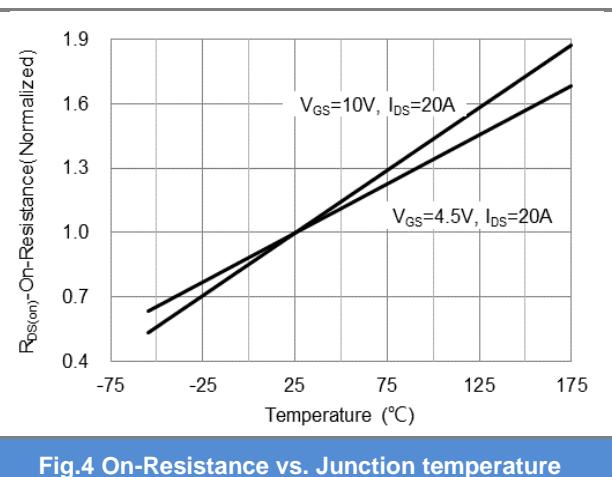


Fig.4 On-Resistance vs. Junction temperature

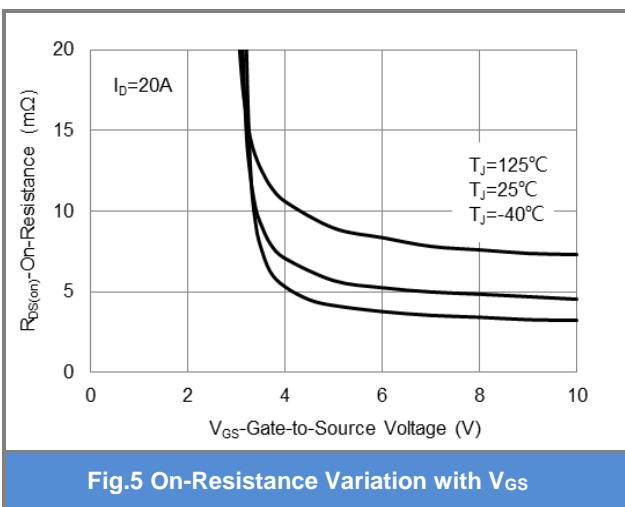


Fig.5 On-Resistance Variation with Vgs

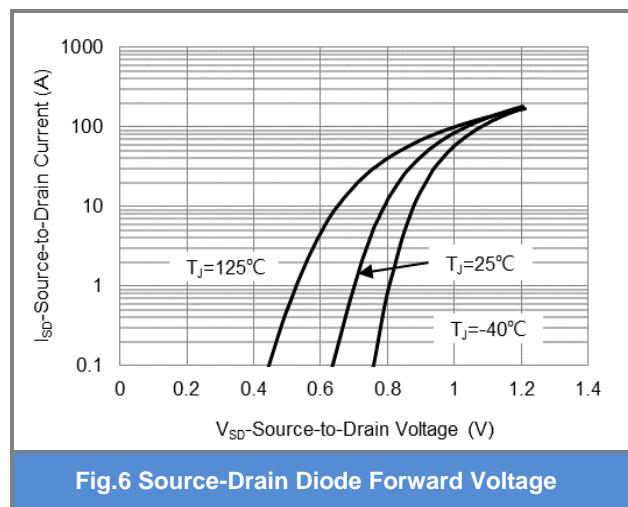


Fig.6 Source-Drain Diode Forward Voltage

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TYPICAL CHARACTERISTIC CURVES

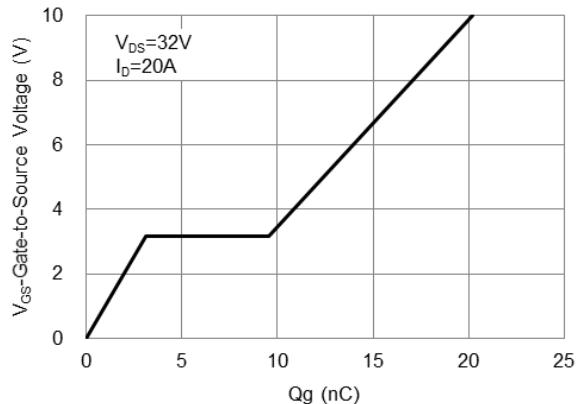


Fig.7 Gate-Charge Characteristics

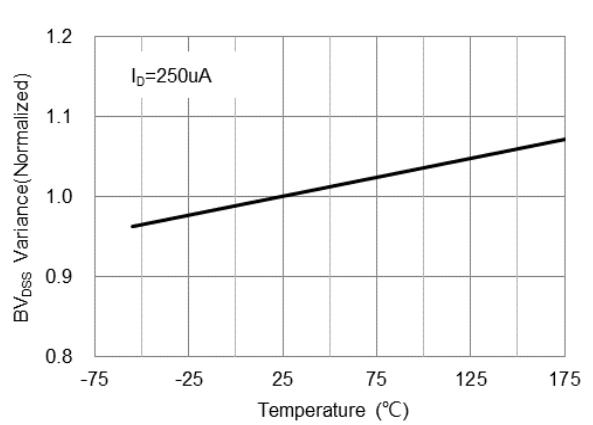


Fig.8 Breakdown Voltage Variation vs. Temperature

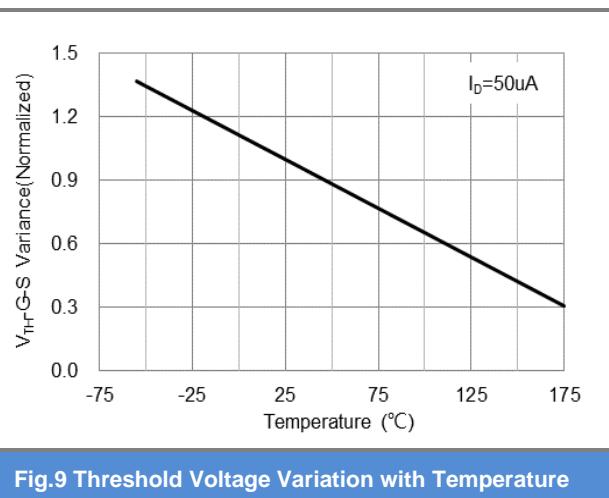


Fig.9 Threshold Voltage Variation with Temperature

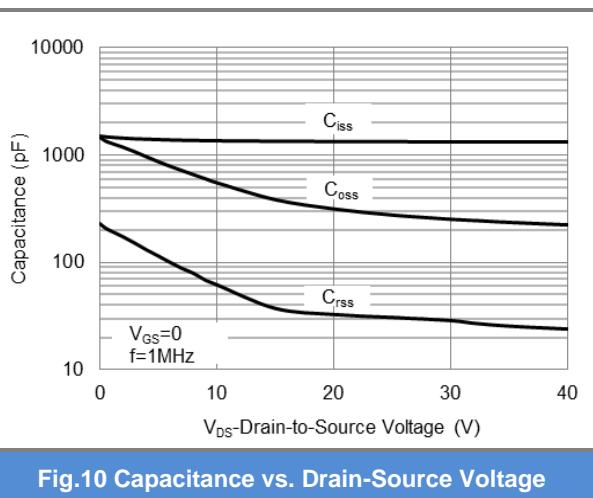


Fig.10 Capacitance vs. Drain-Source Voltage

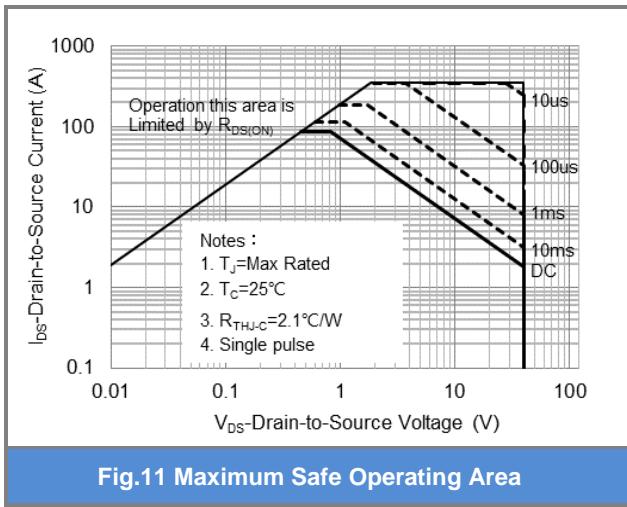


Fig.11 Maximum Safe Operating Area

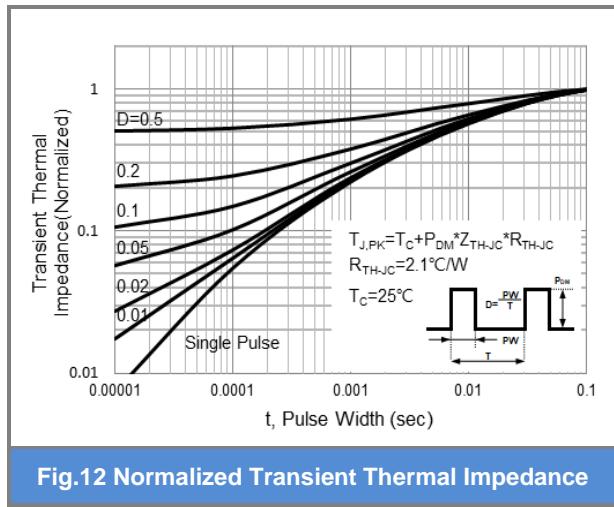


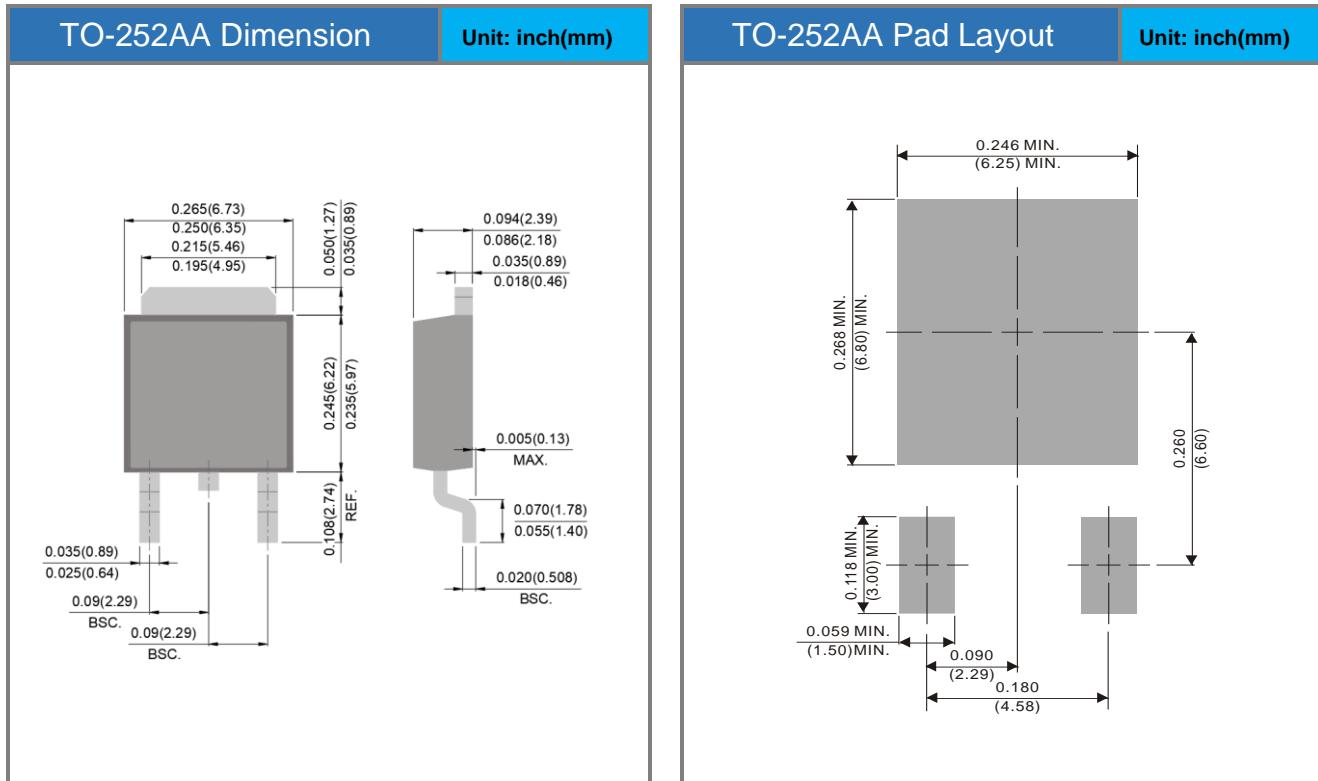
Fig.12 Normalized Transient Thermal Impedance

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Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJD55N04S-AU	TO-252AA	3K pcs / 13" reel	D55N04S

Packaging Information & Mounting Pad Layout



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